



600 Watt Surface Mount Transient Voltage Suppressor

Screening in
reference to
MIL-PRF-19500
available

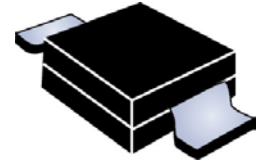
DESCRIPTION

The MSMB 5.0A – MSMB 170CA series of surface mount 600 watt transient voltage suppressors provide a selection of standoff voltages (V_{wm}) from 5.0 to 170 V. These high-reliability devices are available in either unidirectional or bidirectional versions. The SMBG Gull-wing design in the DO-215AA package is ideal for visible solder connections. The SMBJ J-bend design in the DO-214AA package allows for greater PC board mounting density. It is available with SnPb or RoHS compliant matte-tin plating.

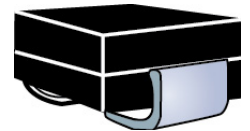
Important: For the latest information, visit our website <http://www.microsemi.com>.

FEATURES

- High reliability devices with wafer fabrication and assembly lot traceability.
- All devices 100% surge tested.
- Enhanced reliability screening in reference to MIL-PRF-19500 is also available. Refer to [High Reliability Up-Screened Plastic Products Portfolio](#) for more details on the screening options.
(See [part nomenclature](#) for all options.)
- Moisture classification is Level 1 with no dry pack required per IPC/JEDEC J-STD-020B.
- 3 σ lot norm screening performed on standby current (I_D).
- RoHS compliant versions available.



**DO-215AA
Gull-wing Package**



**DO-214AA
J-bend Package**


NOTE: All SMB series are equivalent to prior SMS package identifications.

APPLICATIONS / BENEFITS

- Protects sensitive components such as IC's, CMOS, Bipolar, BiCMOS, ECL, DTL, T2L, etc.
- Protection from switching transients & RF induced voltage pulses.
- Protection from ESD and EFT per IEC 61000-4-2 and IEC 61000-4-4.
- Secondary lightning protection per IEC61000-4-5 with 42 ohms source impedance:
 - Class 1: MSB 5.0A to MSMB 120CA
 - Class 2: MSMB 5.0A to MSMB 60CA
 - Class 3: MSMB 5.0A to MSMB 30CA
 - Class 4: MSMB 5.0A to MSMB 15CA
- Secondary lightning protection per IEC61000-4-5 with 12 ohms source impedance:
 - Class 1: MSMB 5.0A to MSMB 36CA
 - Class 2: MSMB 5.0A to MSMB 18CA

Also available in:

 **Commercial Grade**
[SMBJ5.0A – SMBJ170CAe3](#)

 **T-18 package**
(axial-leaded)
[P6KE6.8A – P6KE200CAe3](#)

MAXIMUM RATINGS @ 25 °C unless otherwise stated

Parameters/Test Conditions	Symbol	Value	Unit
Junction and Storage Temperature	T_J and T_{STG}	-65 to +150	°C
Thermal Resistance, Junction to Lead	$R_{\theta JL}$	25	°C/W
Thermal Resistance, Junction to Ambient ⁽¹⁾	$R_{\theta JA}$	90	°C/W
Peak Pulse Power Dissipation ⁽²⁾	P_{PP}	600	W
Rated Average Power Dissipation ⁽¹⁾	@ $T_L \leq 25$ °C	5	W
	@ $T_A = 25$ °C	1.38	
$T_{clamping}$ (0 volts to $V_{(BR)}$ min)	Unidirectional	< 100	ps
	Bidirectional	< 5	ns
Forward Surge Current ⁽³⁾	I_{FS}	100	A (pk)
Solder Temperature @ 10 s	T_{SP}	260	°C

- Notes:**
1. When mounted on FR4 PC board (1oz Cu) with recommended footprint (see [pad layout](#) on last page).
 2. With impulse repetition rate (duty factor) of 0.01 % or less (also [Figure 1 and 4](#)).
 3. Peak impulse of 8.3 ms half-sine wave (unidirectional only).

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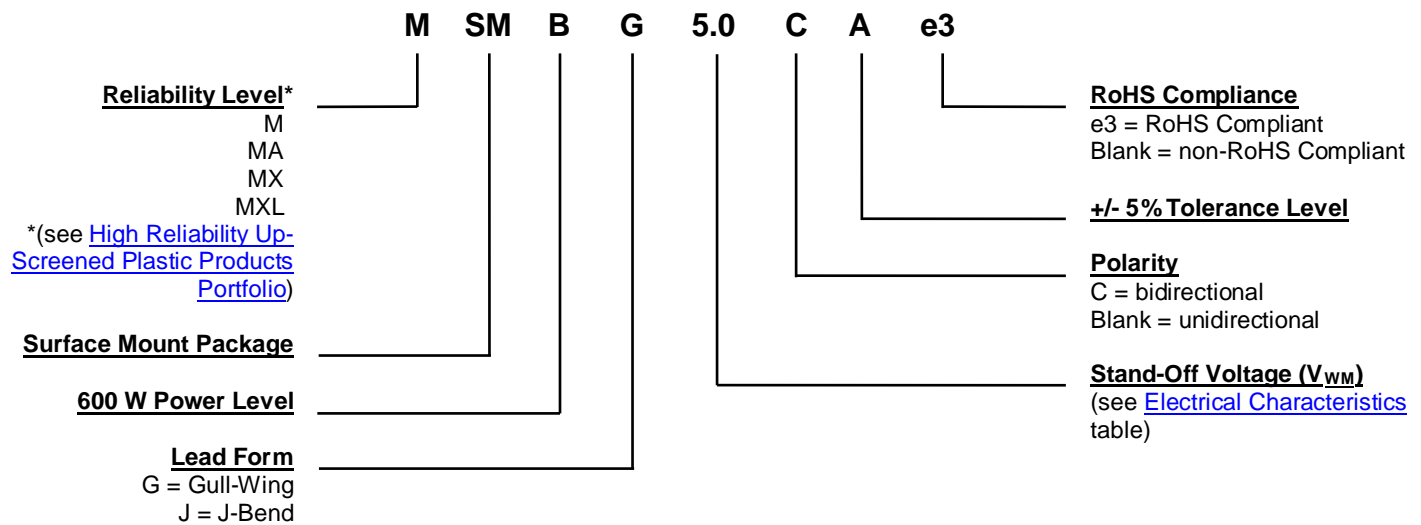
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MECHANICAL and PACKAGING

- CASE: Void-free transfer molded thermosetting epoxy body meeting UL94V-0 requirements.
- TERMINALS: Tin-lead or RoHS compliant annealed matte-tin plating readily solderable per MIL-STD-750, method 2026.
- MARKING: Part number.
- POLARITY: Cathode end banded.
- TAPE & REEL option: Standard per EIA-481-1-A (add "TR" suffix to part number). Consult factory for quantities.
- WEIGHT: Approximately 0.1 grams.
- See [Package Dimensions](#) on last page.

PART NOMENCLATURE

SYMBOLS & DEFINITIONS

Symbol	Definition
V_{WM}	Working Peak (Standoff) Voltage - The maximum peak voltage that can be applied over the operating temperature range. This is also referred to as standoff voltage.
P_{PP}	Peak Pulse Power - Rated random recurring peak impulse power dissipation.
$V_{(BR)}$	Breakdown Voltage - The minimum voltage the device will exhibit at a specified current.
I_D	Standby Current - The current at the rated standoff voltage (V_{WM}).
I_{PP}	Peak Pulse Current - The peak current during the impulse.
V_C	Clamping Voltage - Clamping voltage at I_{PP} (peak pulse current) at the specified pulse conditions (typically shown as maximum value).
I_{BR}	Breakdown Current – The current used for measuring breakdown voltage $V_{(BR)}$.

ELECTRICAL CHARACTERISTICS @ 25 °C

PART NUMBER		REVERSE STAND-OFF VOLTAGE VWM	BREAKDOWN VOLTAGE		MAXIMUM CLAMPING VOLTAGE VC @ IPP	PEAK PULSE CURRENT (see Fig. 2) IPP	MAXIMUM STANDBY CURRENT ID @ VWM
Gull-Wing	J-Bend	V	V (BR)	@ I(BR)	V	A	µA
MSMBG5.0A	MSMBJ5.0A	5	6.40 – 7.00	10	9.2	65.2	800
MSMBG6.0A	MSMBJ6.0A	6	6.67 – 7.37	10	10.3	58.3	800
MSMBG6.5A	MSMBJ6.5A	6.5	7.22 – 7.98	10	11.2	53.6	500
MSMBG7.0A	MSMBJ7.0A	7	7.78 – 8.60	10	12	50	200
MSMBG7.5A	MSMBJ7.5A	7.5	8.33 – 9.21	1	12.9	46.5	100
MSMBG8.0A	MSMBJ8.0A	8	8.89 – 9.83	1	13.6	44.1	50
MSMBG8.5A	MSMBJ8.5A	8.5	9.44 – 10.4	1	14.4	41.7	10
MSMBG9.0A	MSMBJ9.0A	9	10.0 – 11.1	1	15.4	39	5
MSMBG10A	MSMBJ10A	10	11.1 – 12.3	1	17	35.3	5
MSMBG11A	MSMBJ11A	11	12.2 – 13.5	1	18.2	33	5
MSMBG12A	MSMBJ12A	12	13.3 – 14.7	1	19.9	30.2	5
MSMBG13A	MSMBJ13A	13	14.4 – 15.9	1	21.5	27.9	1
MSMBG14A	MSMBJ14A	14	15.6 – 17.2	1	23.2	25.8	1
MSMBG15A	MSMBJ15A	15	16.7 – 18.5	1	24.4	24	1
MSMBG16A	MSMBJ16A	16	17.8 – 19.7	1	26	23.1	1
MSMBG17A	MSMBJ17A	17	18.9 – 20.9	1	27.6	21.7	1
MSMBG18A	MSMBJ18A	18	20.0 – 22.1	1	29.2	20.5	1
MSMBG20A	MSMBJ20A	20	22.2 – 24.5	1	32.4	18.5	1
MSMBG22A	MSMBJ22A	22	24.4 – 26.9	1	35.5	16.9	1
MSMBG24A	MSMBJ24A	24	26.7 – 29.5	1	38.9	15.4	1
MSMBG26A	MSMBJ26A	26	28.9 – 31.9	1	42.1	14.2	1
MSMBG28A	MSMBJ28A	28	31.1 – 34.4	1	45.4	13.2	1
MSMBG30A	MSMBJ30A	30	33.3 – 36.8	1	48.4	12.4	1
MSMBG33A	MSMBJ33A	33	36.7 – 40.6	1	53.3	11.3	1
MSMBG36A	MSMBJ36A	36	40.0 – 44.2	1	58.1	10.3	1
MSMBG40A	MSMBJ40A	40	44.4 – 49.1	1	64.5	9.3	1
MSMBG43A	MSMBJ43A	43	47.8 – 52.8	1	69.4	8.6	1
MSMBG45A	MSMBJ45A	45	50.0 – 55.3	1	72.7	8.3	1
MSMBG48A	MSMBJ48A	48	53.3 – 58.9	1	77.4	7.7	1
MSMBG51A	MSMBJ51A	51	56.7 – 62.7	1	82.4	7.3	1
MSMBG54A	MSMBJ54A	54	60.0 – 66.3	1	87.1	6.9	1
MSMBG58A	MSMBJ58A	58	64.4 – 71.2	1	93.6	6.4	1
MSMBG60A	MSMBJ60A	60	66.7 – 73.7	1	96.8	6.2	1
MSMBG64A	MSMBJ64A	64	71.1 – 78.6	1	103	5.8	1
MSMBG70A	MSMBJ70A	70	77.8 – 86.0	1	113	5.3	1
MSMBG75A	MSMBJ75A	75	83.3 – 92.1	1	121	4.9	1
MSMBG78A	MSMBJ78A	78	86.7 – 95.8	1	126	4.7	1
MSMBG85A	MSMBJ85A	85	94.4 – 104	1	137	4.4	1
MSMBG90A	MSMBJ90A	90	100 – 111	1	146	4.1	1
MSMBG100A	MSMBJ100A	100	111 – 123	1	162	3.7	1
MSMBG110A	MSMBJ110A	110	122 – 135	1	177	3.4	1
MSMBG120A	MSMBJ120A	120	133 – 147	1	193	3.1	1
MSMBG130A	MSMBJ130A	130	144 – 159	1	209	2.9	1
MSMBG150A	MSMBJ150A	150	167 – 185	1	243	2.5	1
MSMBG160A	MSMBJ160A	160	178 – 197	1	259	2.3	1
MSMBG170A	MSMBJ170A	170	189 – 209	1	275	2.2	1

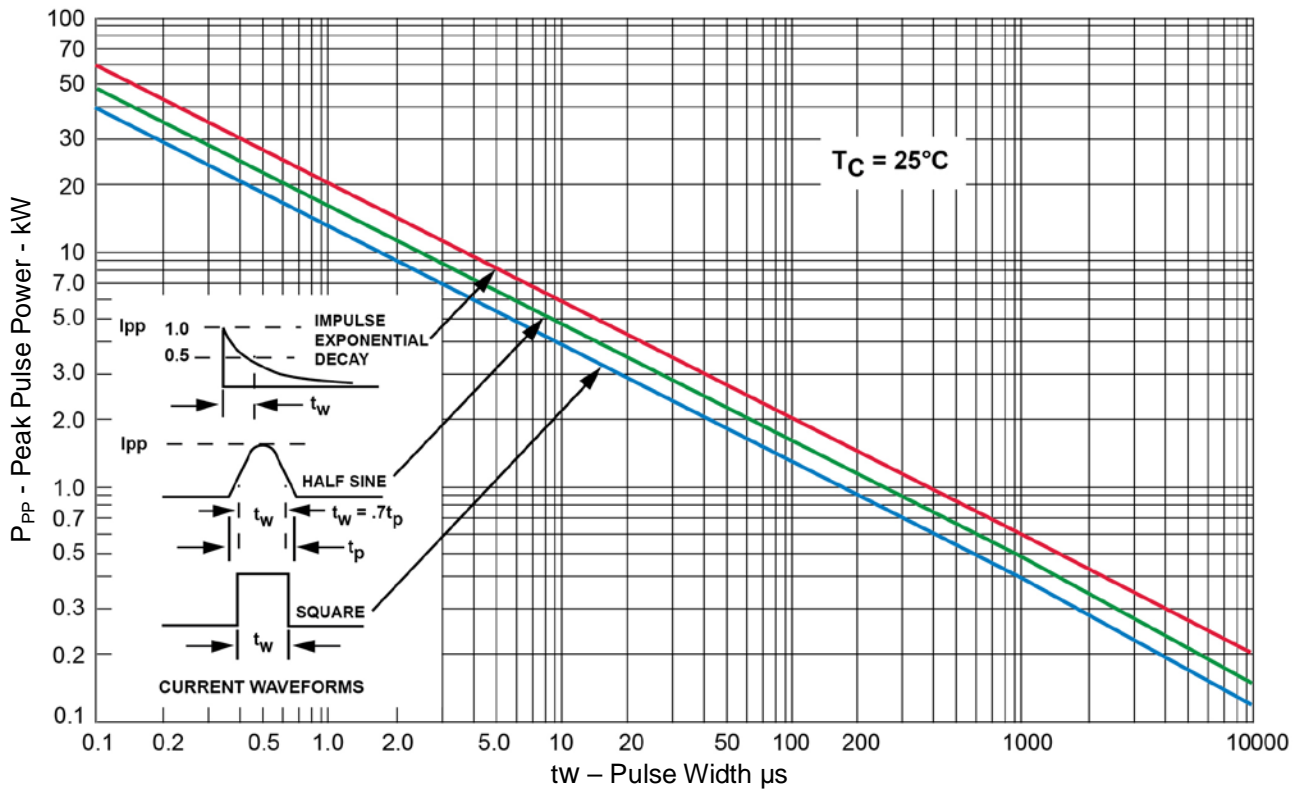
GRAPHS


FIGURE 1
Peak Pulse Power vs Pulse Time

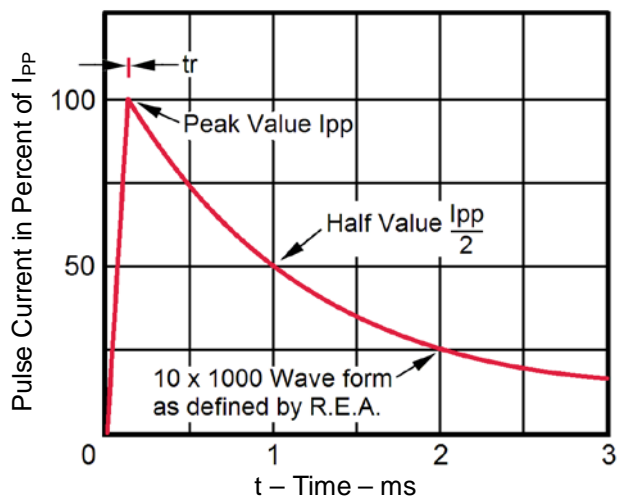


FIGURE 2
Pulse Waveform for 10/1000 Exponential Surge

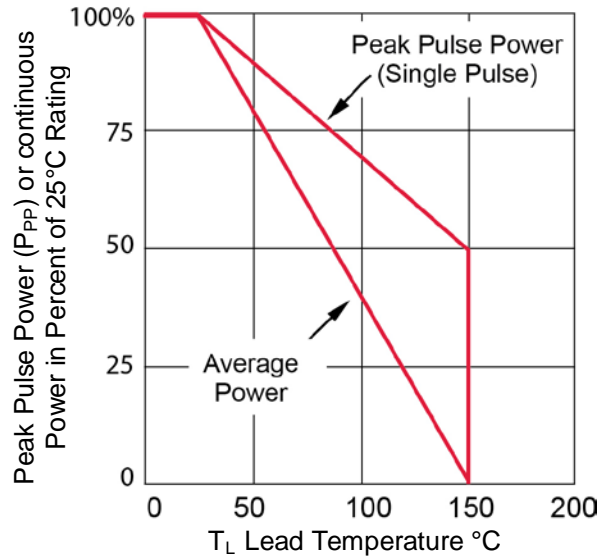
GRAPHS (continued)


FIGURE 3
Derating Curve

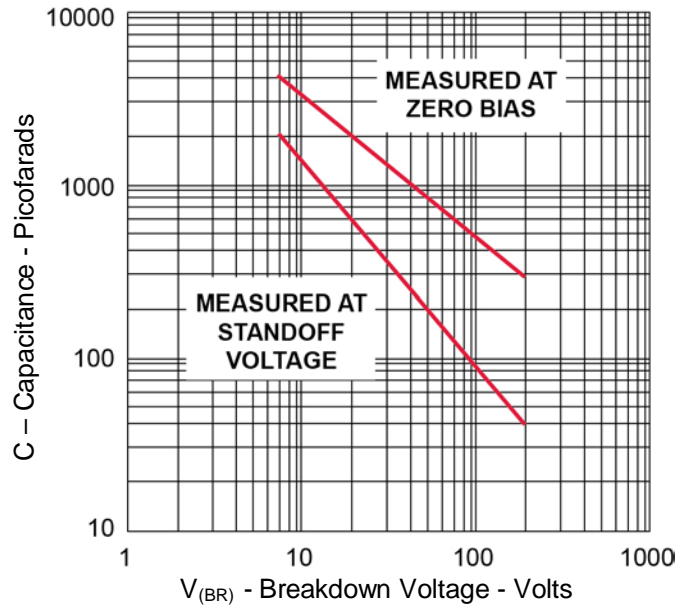
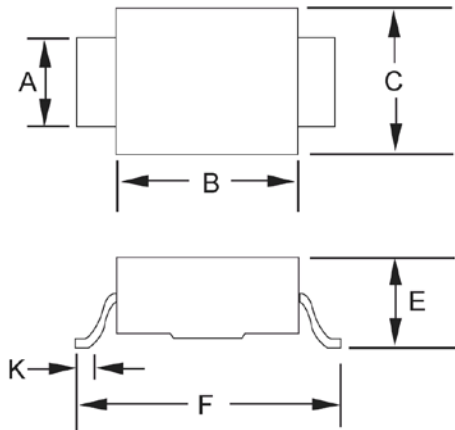
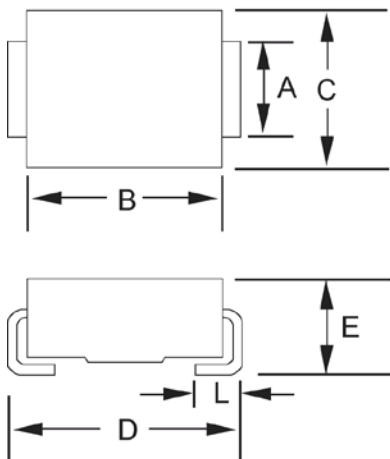


FIGURE 4
Typical Capacitance vs. Breakdown Voltage
NOTE: Bidirectional capacitance is half that shown at zero volts.

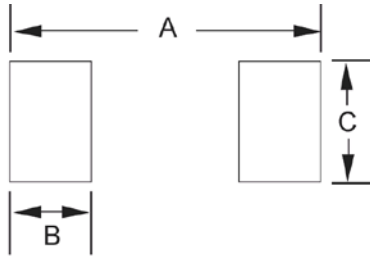
PACKAGE DIMENSIONS

SMBG (DO-215AA)

Ltr	Dimensions			
	Inch		Millimeters	
	Min	Max	Min	Max
A	.077	.083	1.96	2.10
B	.160	.180	4.06	4.57
C	.130	.155	3.30	3.94
E	.077	.104	1.95	2.65
F	.235	.255	5.97	6.48
K	.015	.030	.381	.762


SMBJ (DO-214AA)

Ltr	Dimensions			
	Inch		Millimeters	
	Min	Max	Min	Max
A	.077	.083	1.96	2.10
B	.160	.180	4.06	4.57
C	.130	.155	3.30	3.94
D	.205	.220	5.21	5.59
E	.077	.104	1.95	2.65
L	.030	.060	.760	1.52

See pad layout on next page.

PAD LAYOUT


SMBG (DO-215AA)		
Ltr	Inch	Millimeters
A	0.320	8.13
B	0.085	2.16
C	0.110	2.79

SMBJ (DO-214AA)		
Ltr	Inch	Millimeters
A	0.260	6.60
B	0.085	2.16
C	0.110	2.79